

# 承 認 書

## SPECIFICATION FOR APPROVAL

● 客戶名称

● Customer

● 客戶品號

● Customer Part No.

● 產品品號

HC-J1005AAB65TP-F1-5

● Brightek Part No.

● 產品規格描述

0402 蓝光普亮

● Specification

● 製錶人

王清

● Prepared By

● 審 核

李东平

● Checkedy

● 客 戶 回 簽

● Customer

● 送样日期:

● Deliver date:

說明: 一、謹致執事者: 茲提供敝公司產品之有關詳細規格及圖面資料, 敬請給予辦理測試認定手續。同時敬請 送返一份附有貴公司簽認之測試認定後之樣品認定書。

We are sending you our specification and drawings for your approval. Please return to us one copy "For Approval" with your approved signatures.

二、客戶意見欄 Customer' S Proposal

☐ Approve 承認 (請於認可欄中簽名)

☐ Disagree 不同意

Reason 原因:

光宇集團

中高端光电元件定制企业, 20 多年封装经验, 品质稳定, 值得信赖, 体现光的价值。

光宇集团国际(香港)有限公司

GTU Group International (HK) Co., Limited

广东光宇半导体科技有限公司

工厂地址: 东莞市寮步镇松湖智谷 A2 栋 3 楼

东莞市弘呈光电有限公司

DongGuan Hong cheng Optoelectronics Co., Ltd.

工厂地址: 广东省东莞市樟木头镇莞樟路樟木头段 15 号 15 栋 2108 号

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业务联系人: 李顺阳 13925714318 (微信同号) 销售总监

企业邮箱: [sales@led-hc.com](mailto:sales@led-hc.com)



ISO 14001  
环境管理  
体系认证



ISO 9001  
环境管理  
体系认证



| 版本/版次 | 修改日期 | 修改内容 |
|-------|------|------|
|       |      |      |
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## Features

1.0mm × 0.5mm SMT LED, 0.45mm thickness

Low power consumption

Wide view angle

Package: 4000pcs/reel

RoHS Compliant

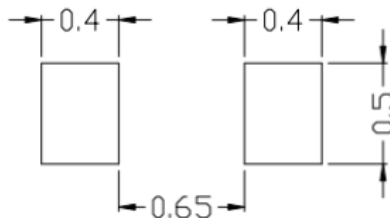
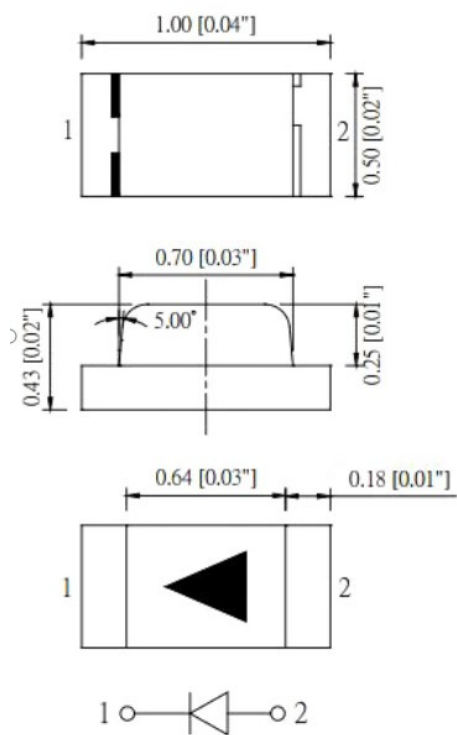
## Applications

Ideal for back light and indicator

Various colors and lens types available

## Package outlines

Recommend Pad Layout



| Part No.             | Emitted color | Dice      | Lens color        |
|----------------------|---------------|-----------|-------------------|
| HC-J1005AAB65TP-F1-5 | Blue          | InGaN/GaN | Water transparent |

### Notes:

1. All dimensions are in millimeters (inches);
2. Tolerances are  $\pm 0.1\text{mm}$  (0.004inch) unless otherwise noted.

### Absolute maximum ratings (TA=25°C)

| Parameter             | Symbol | Value    | Unit |
|-----------------------|--------|----------|------|
| Forward current       | If     | 25       | mA   |
| Reverse voltage       | Vr     | 5        | V    |
| Power dissipation     | Pd     | 72       | mW   |
| Operating temperature | Top    | -40 ~+80 | °C   |
| Storage temperature   | Tstg   | -40 ~+85 | °C   |
| Peak pulsing current  | Ifp    | 100      | mA   |

### Electro-optical characteristics (TA=25°C)

| Parameter                   | Test Condition | Symbol           | Value |     |     | Unit    |
|-----------------------------|----------------|------------------|-------|-----|-----|---------|
|                             |                |                  | Min   | Typ | Max |         |
| Wavelength at peak emission | If=5mA         | $\lambda_p$      | --    | 472 | --  | nm      |
| Spectral half bandwidth     | If=5mA         | $\Delta \lambda$ | --    | 19  | --  | nm      |
| Dominant wavelength         | If=5mA         | $\lambda_d$      | 463   | --  | 473 | nm      |
| Forward voltage             | If=5mA         | Vf               | 2.6   | --  | 3.0 | V       |
| Luminous intensity          | If=5mA         | Iv               | 30    | --  | 70  | mcd     |
| Viewing angle at 50% Iv     | If=10mA        | 2 $\theta$ 1/2   | --    | 120 | --  | Deg     |
| Reverse current             | Vr=5V          | Ir               | --    | --  | 10  | $\mu$ A |

# Optical characteristic curves

## BLUE

(25℃) Ambient Temperature Unless Otherwise Noted

Fig1. Forward Current vs. Forward Voltage

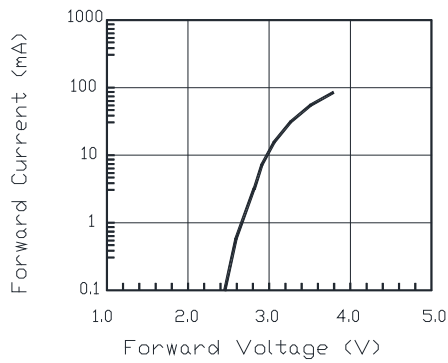


Fig2. Relative Luminous Intensity Vs Forward current

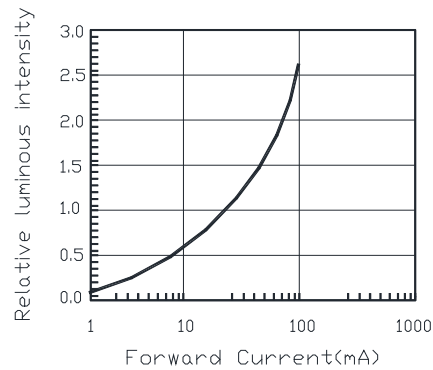


Fig3. Forward Current Derating Curve

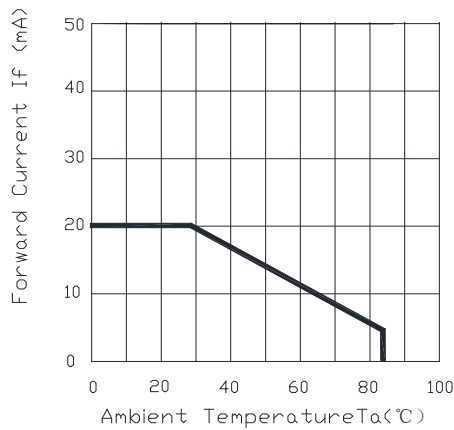


Fig4. Relative Luminous Intensity vs Ambient Temperature

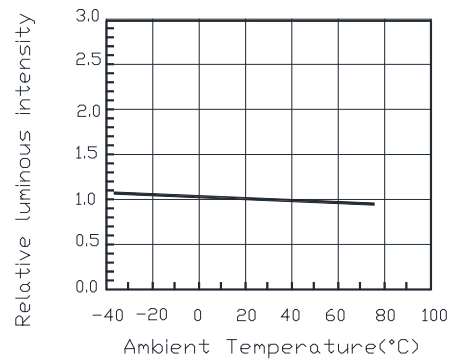


Fig5. Relative Intensity vs. Wavelength

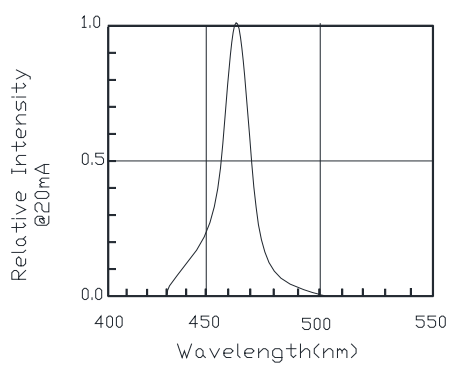
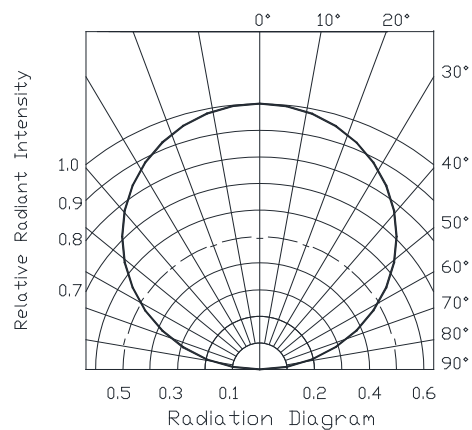
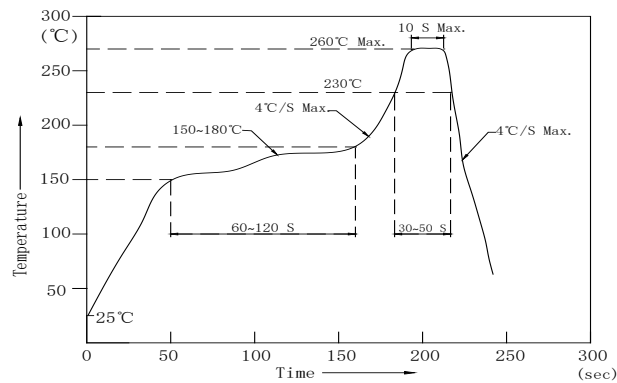


Fig.6 Spatial Distribution



## Reflow Profile

### ■ Reflow Temp/Time



### Notes:

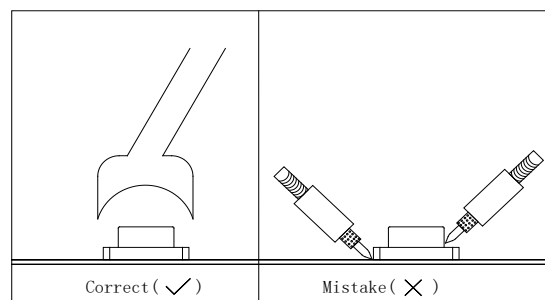
1. We recommend the reflow temperature 245°C(±5°C). the maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 1 times or less.

### ■ Soldering iron

Basic spec is  $\leq 5\text{sec}$  when 260°C. If temperature is higher, time should be shorter (+10°C  $\rightarrow$  -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

### ■ Rework

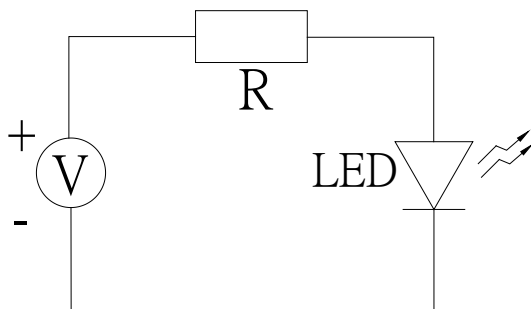
1. Customer must finish rework within 5 sec under 260°C.
2. The head of iron can not touch copper foil
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

## Test circuit and handling precautions

### ■ Test circuit



### ■ Handling precautions

#### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature :  $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$  ( $41^{\circ}\text{F} \sim 86^{\circ}\text{F}$ )

2.2 Shelf life in sealed bag: 12 month at  $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$  and  $<30\%$  R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at  $\leq 20$  R.H. with zip-lock sealed.

#### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1  $60 \pm 3^{\circ}\text{C}$  x(12~24hrs) and  $<5\%$  RH, taped reel type

3.2  $100 \pm 3^{\circ}\text{C}$  x(45min~1hr), bulk type

3.3  $130 \pm 3^{\circ}\text{C}$  x(15~30min), bulk type

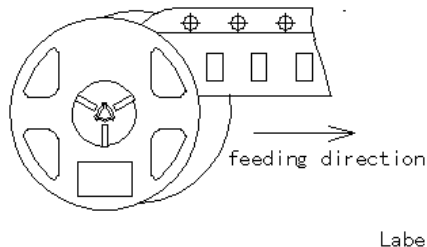
## Test items and results of reliability

| Type                   | Test Item                    | Test Conditions                 | Note      | Number of Damaged |
|------------------------|------------------------------|---------------------------------|-----------|-------------------|
| Environmental Sequence | Temperature Cycle            | -20℃ 30min<br>↑ ↓<br>80℃ 30min  | 100 cycle | 0/22              |
|                        | Thermal Shock                | -20℃ 15min<br>↑ ↓<br>80℃ 15min  | 100 cycle | 0/22              |
|                        | High Humidity Heat Cycle     | 30℃ ⇔ 65℃<br>90%RH 24hrs/1cycle | 10 cycle  | 0/22              |
|                        | High Temperature Storage     | Ta=80℃                          | 1000 hrs  | 0/22              |
|                        | Humidity Heat Storage        | Ta=60℃<br>RH=90%                | 1000 hrs  | 0/22              |
|                        | Low Temperature Storage      | Ta=-30℃                         | 1000 hrs  | 0/22              |
| Operation Sequence     | Life Test                    | Ta=25℃<br>IF=20mA               | 1000 hrs  | 0/22              |
|                        | High Humidity Heat Life Test | 60℃ RH=90%<br>IF=10mA           | 500 hrs   | 0/22              |
|                        | Low Temperature Life Test    | Ta=-20℃<br>IF=20mA              | 1000 hrs  | 0/22              |

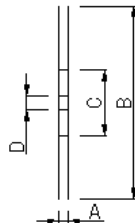
# 1005 Series SMD Chip LED Lamps Packaging Specifications

## • Feeding Direction

## • Dimensions of Reel(Unit:mm)

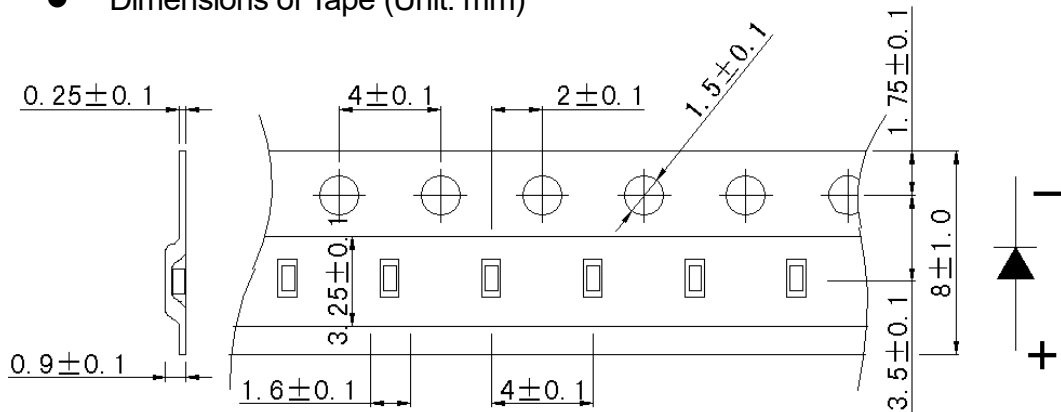


Label

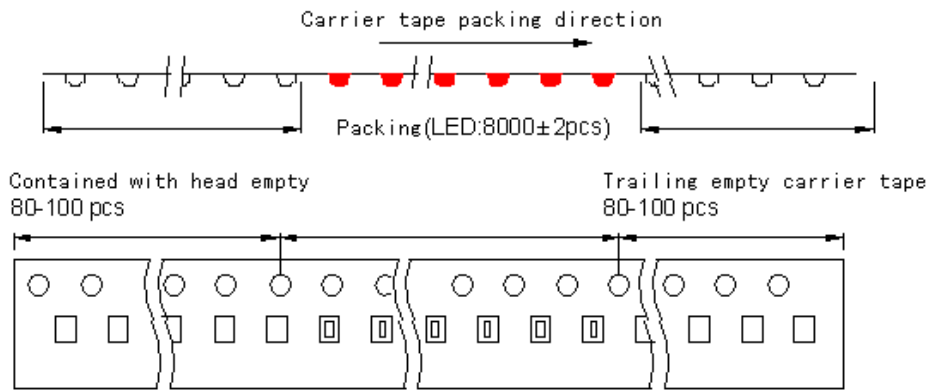


|   |                          |
|---|--------------------------|
| A | $8.0 \pm 0.1 \text{mm}$  |
| B | $178 \pm 1 \text{mm}$    |
| C | $60 \pm 1 \text{mm}$     |
| D | $13.0 \pm 0.5 \text{mm}$ |

## • Dimensions of Tape (Unit: mm)



## • Arrangement of tape:

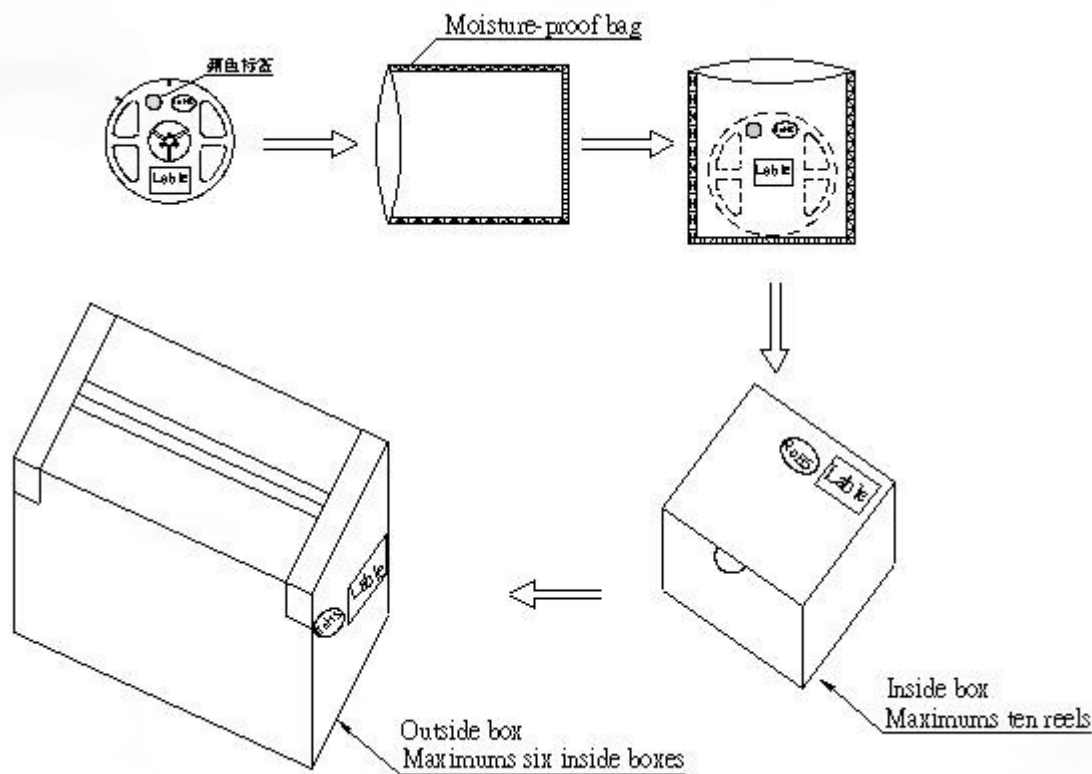


## Notes:

1. Empty component pockets are sealed with top cover tape;
2. The maximum number of missing lamps is two;
3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
4. 4,000 pcs/Reel.

## 1005 Series SMD Chip LED Lamps Packaging Specifications

- Packaging specifications



### Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 40,000pcs) packed in an inside box (about size: 240x 220x 120mm) and four inside boxes of maximums are put in the outside box (about size: 460mm x 246mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.